



Features and Benefits

- Exceptional reliability
- Small fully-molded SIP package with heatsink mounting for high thermal dissipation and long life
- V_{DRM} of 600 V
- 16 A_{RMS} on-state current
- Uniform switching
- UL Recognized Component



Package: 3-pin SIP (TO-220F)



Description

This Sanken triac (bidirectional triode thyristor) is designed for AC power control, providing reliable, uniform switching for full-cycle AC applications.

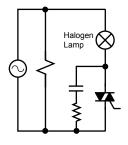
Incomparison with other products on the market, the TMA166H-L provides increased isolation voltage (1800 VAC $_{RMS}$), guaranteed for up to 1 minute, and greater peak nonrepetitive off-state voltage, V_{DSM} (700 V). In addition, commutation dv/dt and (dv/dt)c are improved.

Applications

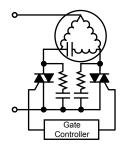
- Residential and commercial appliances: vacuum cleaners, rice cookers, TVs, home entertainment
- White goods: washing machines
- Office automation power control, photocopiers
- Motor control for small tools
- Temperature control, light dimmers, electric blankets
- General use switching mode power supplies (SMPS)

Not to scale

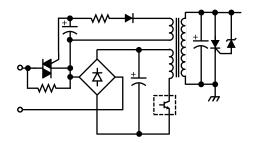
Typical Applications



Heater control (for example, LBP. PPC, MFP)



Two-phase motor control (for example, washing machine)



In-rush current control (for example, SMPS)

Triac (Bidirectional Triode Thyristor)

Selection Guide

Part Number	Package	Packing	
TMA166H-L	3-pin fully molded SIP with heatsink mount	50 pieces per tube	

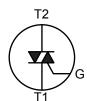
Absolute Maximum Ratings

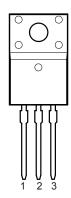
Characteristic	Symbol		Notes	Rating	Units
Peak Repetitive Off-State Voltage	V_{DRM}	R _{GREF} = ∞		600	V
Peak Non-Repetitive Off-State Voltage	V_{DSM}	R _{GREF} = ∞	R _{GREF} = ∞		V
Isolation Voltage	V _{ISO}	AC RMS app	AC RMS applied for 1 minute between lead and case		V
RMS On-State Current	I _{T(RMS)}		50/60 Hz full cycle sine wave, total Conduction angle (α +) + (α -) = 360°, T _C = 65°C		А
	I _{TSM}	f = 60 Hz	Full cycle sine wave, peak value, non-repetitive, initial T _J = 25°C	168	Α
Surge On-State Current		f = 50 Hz		160	Α
I ² t Value for Fusing	I ² t	Value for 50 l	Value for 50 Hz half cycle sine wave, 1 cycle, I _{TSM} = 160 A		A ² •s
Critical Rising Rate of On-State Current	di/dt		$\begin{split} I_T &= I_{T(RMS)} \times \sqrt{2}, V_D = V_{DRM} \times 0.5, f \leq 60 \text{ Hz}, t_{gw} \geq 10 \mu\text{s}, \\ t_{gr} \leq 250 \text{ ns}, I_{gp} \geq 60 \text{ mA (refer to Gate Trigger Current diagram)} \end{split}$		A/µs
Peak Gate Current	I _{GM}	f≥50 Hz, dut	f ≥ 50 Hz, duty cycle ≤ 10%		Α
Peak Gate Power Dissipation	P_{GM}	f ≥ 50 Hz, duty cycle ≤ 10%		5	W
Average Gate Power Dissipation	P _{GM(AV)}			0.5	W
Junction Temperature	TJ			-40 to 125	°C
Storage Temperature	T _{stg}			-40 to 125	°C

Thermal Characteristics May require derating at maximum conditions

Characteristic	Symbol	Test Conditions	Value	Units
Package Thermal Resistance (Junction to Case)	$R_{ heta JC}$	For AC	3.3	°C/W

Pin-out Diagram





Terminal List Table

Number	Name	Function
1	T1	Main terminal, gate referenced
2	T2	Main terminal connect to signal side
3	G	Gate control

All performance characteristics given are typical values for circuit or system baseline design only and are at the nominal operating voltage and an ambient temperature, T_A , of 25°C, unless otherwise stated.





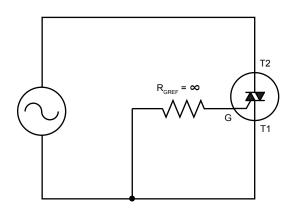
Triac (Bidirectional Triode Thyristor)

ELECTRICAL CHARACTERISTICS

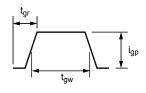
Characteristics	Symbol	Test Conditions		Min.	Тур.	Max.	Unit
Off State Leakage Current	I _{DRM}	V _D = V _{DRM} , T _J = 125°C, R _{GREF} = ∞ using test circuit 1		_	_	2.0	mA
Off-State Leakage Current		V _D = V _{DRM} , T _J = 25°C, R _{GREF} = ∞ using test circuit 1		_	_	100	μA
On-State Voltage	V _{TM}	I _T = 20 A, T _J = 25°C	$I_T = 20 \text{ A}, T_J = 25^{\circ}\text{C}$			1.45	V
		Quadrant I: T2+, G+	V _D = 12 V, R _L = 20 Ω, T _J = 25°C	-	-	1.5	V
Gate Trigger Voltage	V _{GT}	Quadrant II: T2+, G-		-	-	1.5	V
		Quadrant III: T2-, G-		-	_	1.5	V
	I _{GT}	Quadrant I: T2+, G+	V _D = 12 V, R _L = 20 Ω, T _J = 25°C	_	_	30	mA
Gate Trigger Current		Quadrant II: T2+, G-		_	_	30	mA
		Quadrant III: T2-, G-		_	_	30	mA
Gate Non-trigger Voltage	V_{GD}	$V_D = V_{DRM} \times 0.5$, $R_L = 4 \text{ k}\Omega$, $T_J = 125 ^{\circ}\text{C}$ $V_D = 400 \text{ V}$, $(\text{di/dt})\text{c} = -8 \text{ A/ms}$, $I_{TP} = 2 \text{ A}$, $T_J = 125 ^{\circ}\text{C}$ $V_D = V_{DRM} \times 0.66$, $R_{GREF} = \infty$ using test circuit 1, $T_J = 125 ^{\circ}\text{C}$		0.2	_	_	V
Critical Rising Rate of Off-State Voltage during Commutation*	(dv/dt)c			10	_	-	V/µs
Critical Rising Rate of Off-StateVoltage	dv/dt			200	_	_	V/µs

^{*}Where I_{TP} is the peak current through T2 to T1.

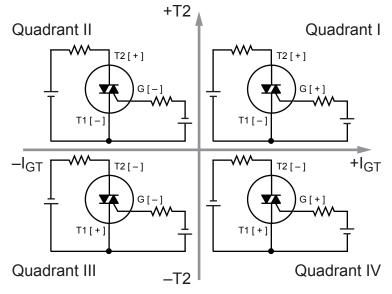
Test Circuit 1



Gate Trigger Current



Gate Trigger Characteristics

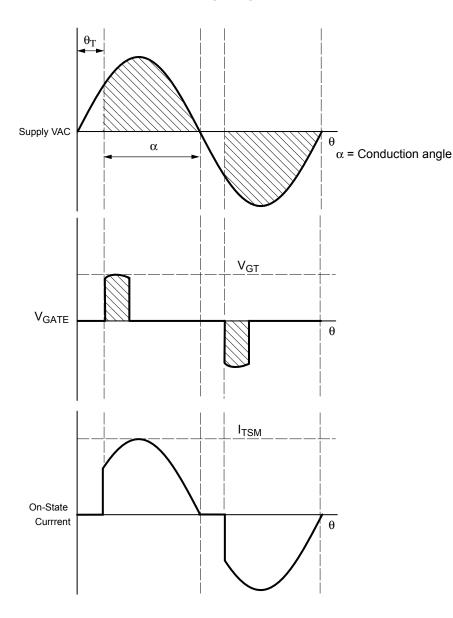


Polarities referenced to T1



Triac (Bidirectional Triode Thyristor)

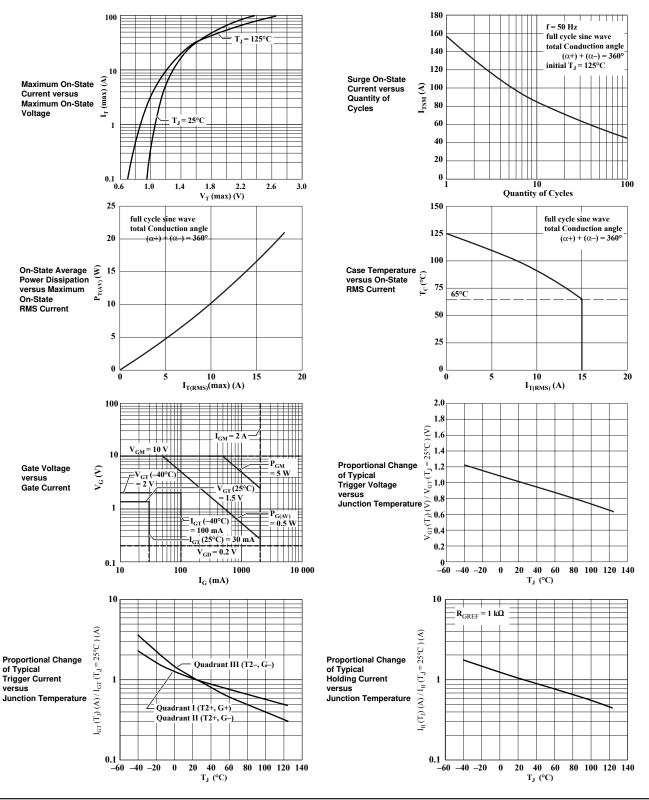
Commutation Timing Diagrams





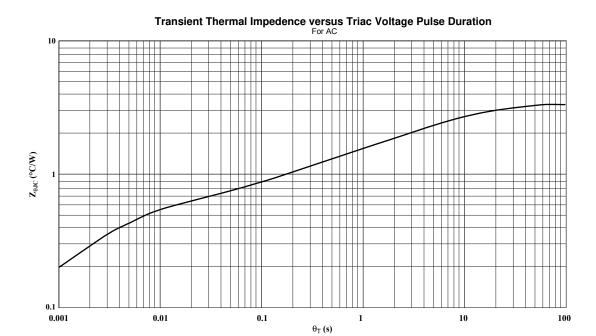


Performance Characteristics at T_A = 25°C





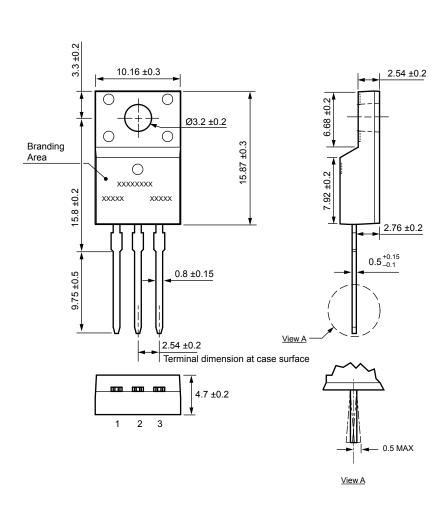


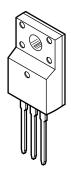






TO-220F Package Outline Drawing





Terminal core material: Cu Terminal treatment: Sn plating

Package: TO-220F

Dimensions in millimeters

Branding codes (exact appearance at manufacturer discretion):

1st line, type: MA166H YMDDR 2nd line left, lot:

Where: Y is the last digit of the year of manufacture

M is the month (1 to 9, O, N, D)

DD is the date R is a tracking letter

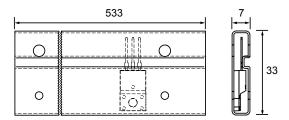


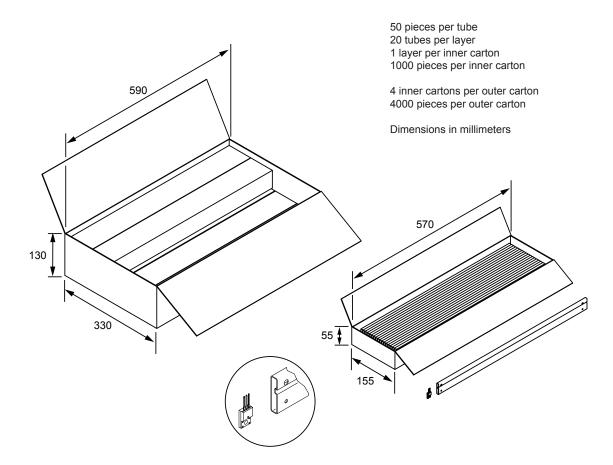




Packing Specification

Tube Packing









Triac (Bidirectional Triode Thyristor)

WARNING — These devices are designed to be operated at lethal voltages and energy levels. Circuit designs that embody these components must conform with applicable safety requirements. Precautions must be taken to prevent accidental contact with power-line potentials. Do not connect grounded test equipment.

The use of an isolation transformer is recommended during circuit development and breadboarding.

Because reliability can be affected adversely by improper storage environments and handling methods, please observe the following cautions.

Cautions for Storage

- Ensure that storage conditions comply with the standard temperature (5°C to 35°C) and the standard relative humidity (approximately 40% to 75%); avoid storage locations that experience extreme changes in temperature or humidity.
- Avoid locations where dust or harmful gases are present and avoid direct sunlight.
- Reinspect for rust on leads and solderability of products that have been stored for a long time.

Cautions for Testing and Handling

When tests are carried out during inspection testing and other standard test periods, protect the products from power surges from the testing device, shorts between adjacent products, and shorts to the heatsink.

Remarks About Using Silicone Grease with a Heatsink

- When silicone grease is used in mounting this product on a heatsink, it shall be applied evenly and thinly. If more silicone grease than required is applied, it may produce stress.
- Coat the back surface of the product and both surfaces of the insulating plate to improve heat transfer between the product and the heatsink.
- Volatile-type silicone greases may permeate the product and produce cracks after long periods of time, resulting in reduced heat radiation effect, and possibly shortening the lifetime of the product.
- · Our recommended silicone greases for heat radiation purposes,

which will not cause any adverse effect on the product life, are indicated below:

Type		Suppliers
	G746	Shin-Etsu Chemical Co., Ltd.
	YG6260	Momentive Performance Materials
	SC102	Dow Corning Toray Silicone Co., Ltd.

Heatsink Mounting Method

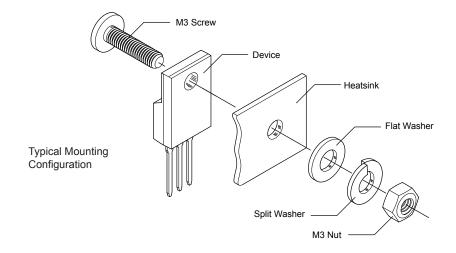
- Torque When Tightening Mounting Screws. Thermal resistance increases when tightening torque is low, and radiation effects are decreased. When the torque is too high, the screw can strip, the heatsink can be deformed, and distortion can arise in the product frame. To avoid these problems, observe the recommended tightening torques for this product package type 0.490 to 0.686 N·m (5 to 7 kgf·cm).
- For effective heat transfer, the contact area between the product and the heatsink should be free from burrs and metal fragments, and the heatsink should be flat and large enough to contact over the entire side of the product, including mounting flange and exposed thermal pad.
- The mounting hole in customer-supplied heatsink must be less than Ø4 mm; this includes the diameter of any dimple around punched holes. This is to prevent possible deflection and cracking of the product case when fastened to the heatsink.

Soldering

 When soldering the products, please be sure to minimize the working time, within the following limits:

260°C 10 s 350°C 3 s

 Soldering iron should be at a distance of at least 1.5 mm from the body of the products







Triac (Bidirectional Triode Thyristor)

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